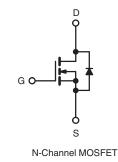


Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	50			
R _{DS(on)} (Ω)	$V_{GS} = 10 V$	0.10		
Q _g (Max.) (nC)	17			
Q _{gs} (nC)	9.0			
Q _{gd} (nC)	3.0			
Configuration	Single			





FEATURES

- Extremely Low R_{DS(on)}
- Compact Plastic Package
- Fast Switching
- Low Drive Current
- Ease of Paralleling
- Excellent Temperature Stability
- Parts Per Million Quality
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

The technology has expanded its product base to serve the low voltage, very low $R_{DS(on)}$ MOSFET transistor requirements. Vishay's highly efficient geometry and unique processing have been combined to create the lowest on resistance per device performance. In addition to this feature all have documented reliability and parts per million quality!

The transistor also offer all of the well established advantages of MOSFETs such as voltage control, very fast switching, ease of paralleling, and temperature stability of the electrical parameters.

They are well suited for applications such as switching power supplies, motor controls, inverters, choppers, audio amplifiers, high energy pulse circuits, and in systems that are operated from low voltage batteries, such as automotive, portable equipment, etc.

ORDERING INFORMATION			
Package	TO-220AB		
Lead (Pb)-free	IRFZ20PbF		
	SiHFZ20-E3		
SnPb	IRFZ20		
	SiHFZ20		

ABSOLUTE MAXIMUM RATINGS					
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage ^a			V _{DS}	50	V
Gate-Source Voltage ^a			V _{GS}	± 20	v
Continuous Drain Current	V at 10 V	T _C = 25 °C T _C = 100 °C	1	15	
Continuous Drain Current	V_{GS} at 10 V $T_C =$	T _C = 100 °C	ID	10	A
Pulsed Drain Current ^b			I _{DM}	60	
Single Pulse Avalanche Energy ^c			E _{AS}	5	mJ
Linear Derating Factor (see fig. 16)				0.32	W/°C
Maximum Power Dissipation (see fig. 16) $T_{C} = 25 \text{ °C}$		PD	40	W	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 150	°C
Soldering Recommendations (Peak Temperature) for 10 s			300 (0.063" (1.6 mm) from case	U	

Notes

a. $T_J = 25 \text{ °C to } 150 \text{ °C}$

b. Repeditive rating: Pulse width limited by max. junction temperature. See transient temperature impedance curve (see fig. 11).

c. Starting T_J = 25 °C, L = 0.07 mH, R_g = 25 Ω , I_{AS} = 12 A

* Pb containing terminations are not RoHS compliant, exemptions may apply



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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Typical Socket Mount, Junction-to-Ambient	R _{thJA}	-	80		
Case-to-Sink, Mounting Surface Flat, Smooth, and Greased	R _{thCS}	1.0	-	°C/W	
Junction-to-Case	R _{thJC}	-	3.12		

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static						•	
Drain-Source Breakdown Voltage	V _{DS}	V _{GS}	= 0 V, I _D = 250 μA	50	-	-	V
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} :	= V _{GS} , I _D = 250 μΑ	2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}		$V_{GS} = \pm 20 V$	-	-	± 500	nA
		V_{DS} > Max. Rating, V_{GS} = 0 V		-	-	250	
Zero Gate Voltage Drain Current	I _{DSS}		. Rating x 0.8, $V_{GS} = 0 V$, T _C = 125 °C	-	-	1000	μA
On-State Drain Current	I _{D(on)}	V _{GS} = 10 V	$V_{DS} > I_{D(on)} \times R_{DS(on)} \max$.	-	-	15	Α
Drain-Source On-State Resistance ^b	R _{DS(on)}	$V_{GS} = 10 V$	I _D = 10 A	-	0.080	0.10	Ω
Forward Transconductance ^b	9 _{fs}	$V_{DS} > I_{D(on)}$	$x R_{DS(on)}$ max., $I_D = 9.0 A$	5.0	6.0	-	S
Dynamic							
Input Capacitance	C _{iss}		V _{GS} = 0 V,	-	560	860	
Output Capacitance	C _{oss}]	$V_{DS} = 25 V,$	-	250	350	pF
Reverse Transfer Capacitance	C _{rss}	f = 1.	.0 MHz, see fig. 11	-	60	100	
Total Gate Charge	Qg		$\label{eq:VGS} \begin{array}{c} I_D = 20 \text{ A}, \ V_{DS} = 0.8 \text{ max}.\\ \text{rating, see fig. 18 for test}\\ \text{circuit (Gate charge is} \end{array}$		12	17	nC
Gate-Source Charge	Q_gs	V _{GS} = 10 V			9.0	-	
Gate-Drain Charge	Q _{gd}		essentially independent of operating temperature)	-	3.0	-]
Turn-On Delay Time	t _{d(on)}	$V_{DD} = 25 \text{ V}, \text{ I}_{D} = 9.0 \text{ A},$ $Z_{0} = 50 \Omega, \text{ see fig. } 5^{\text{b}}$		-	15	30	- ns
Rise Time	t _r			-	45	90	
Turn-Off Delay Time	t _{d(off)}			-	20	40	
Fall Time	t _f			-	15	30	
Internal Drain Inductance	L _D	Modified MOSFET symbol showing the internal device inductances		-	3.5	-	
Internal Source Inductance	L _S			-	4.5	-	nH
Drain-Source Body Diode Characteristic	s				•	•	
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction rectifier		-	-	15	A
Pulsed Diode Forward Current ^a	I _{SM}			-	-	60	
Body Diode Voltage ^b	V _{SD}	$T_{C} = 25 \text{ °C}, I_{S} = 15 \text{ A}, V_{GS} = 0 \text{ V}$		-	-	1.5	V
Body Diode Reverse Recovery Time	t _{rr}	T 150 °C	= -15 A d	-	100	-	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$T_{J} = 150 \text{ °C}, I_{F} = 15 \text{ A}, dI_{F}/dt = 100 \text{ A}/\mu \text{s}$		-	0.4	-	μC
Forward Turn-On Time	t _{on}	Intrinsic tu	urn-on time is negligible (turn	-on is dor	ninated b	vlsand	L _D)

Notes

a. Repeditive rating: Pulse width limited by max. junction temperature. See transient temperature impedance curve (see fig. 5).

b. Pulse test: Pulse width \leq 300 µs; duty cycle \leq 2 %.



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

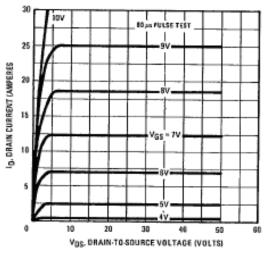


Fig. 1 - Typical Output Characteristics

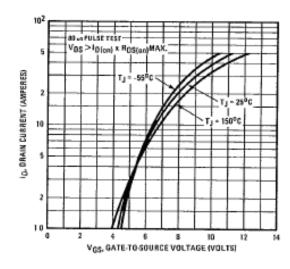


Fig. 3 - Typical Transfer Characteristics

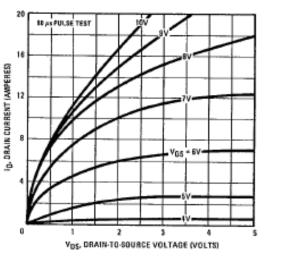


Fig. 2 - Typical Saturation Characteristics

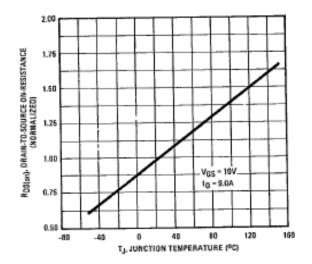


Fig. 4 - Normalized On-Resistance vs. Temperature

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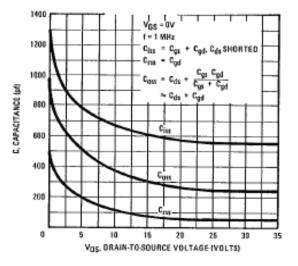


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

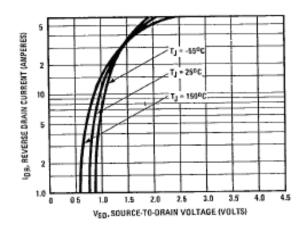


Fig. 7 - Typical Source-Drain Diode Forward Voltage

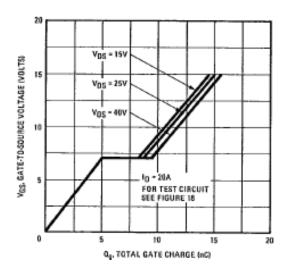


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

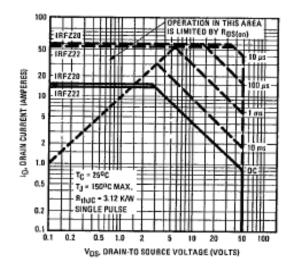


Fig. 8 - Maximum Safe Operating Area



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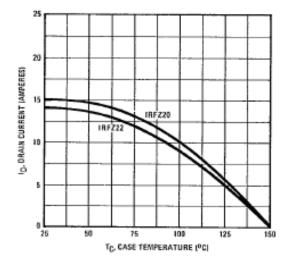


Fig. 9 - Maximum Drain Current vs. Case Temperature

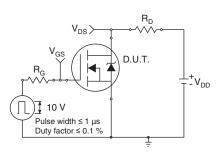


Fig. 10a - Switching Time Test Circuit

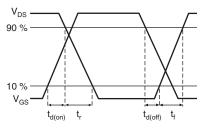


Fig. 10b - Switching Time Waveforms

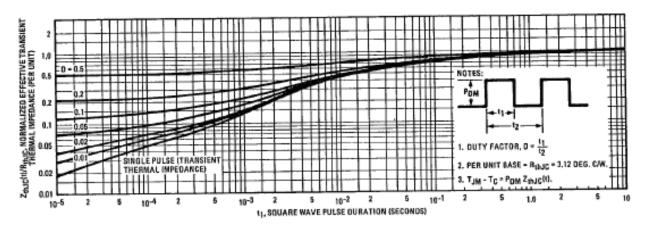
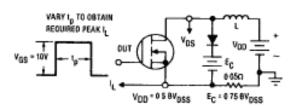


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case vs. Pulse Duration





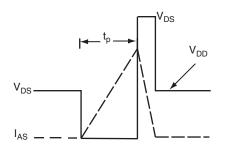


Fig. 12b - Unclamped Inductive Waveforms

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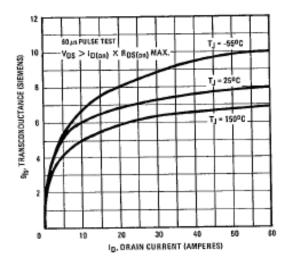


Fig. 13 - Typical Transconductance vs. Drain Current

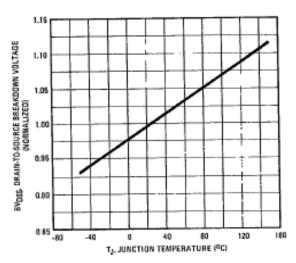


Fig. 14 - Breakdown Voltage vs. Temperature

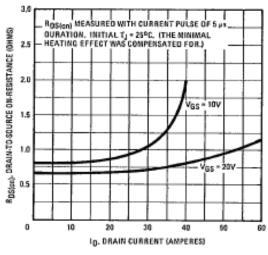


Fig. 15 - Typical On-Resistance vs. Drain Current

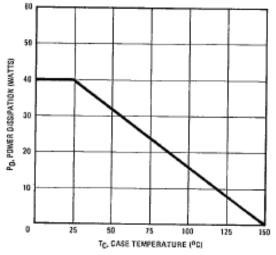
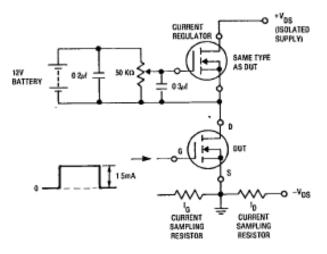


Fig. 16 - Power vs. Temperature Derating Curve







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Peak Diode Recovery dV/dt Test Circuit

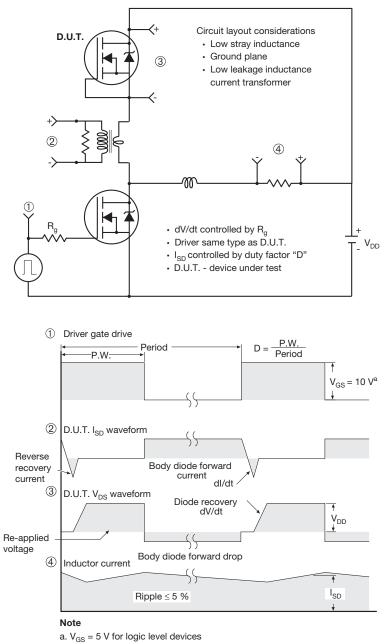


Fig. 14 - For N-Channel

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www.vishay.com

TO-220-1



DIM.	MILLIN	IETERS	INCHES		
DIN.	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
E	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031					

Note

- M^{\star} = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

Package Picture					
ASE		Xi'an			
		IRF 9510 744K AB			

Revison: 14-Dec-15

1 For technical questions, contact: <u>hvm@vishay.com</u> Document Number: 66542

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